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Part Number:

0783590001

Status:

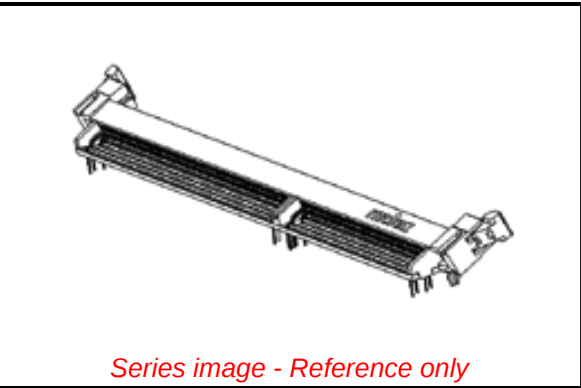
Active

Overview:

DDR3 DIMM Sockets

Description:

1.00mm Pitch DDR3 DIMM Socket, Very Low Profile, 25° Angle, Through Hole, with Beveled Metal Pins, Black Housing and Latches, 0.76µm Gold (Au) Plating, 2.79mm Solder Tail Length, 1.57mm PCB Thickness, 1.5V Center Voltage Key,



Documents:	
3D Model	Product Specification PS-78359-001-001 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E29179
General	
Product Family	Memory Module Sockets
Series	78359
Application Tooling Part Link	62100-1960
Component Type	Socket
Electrical Model	Yes
JEDEC Outline	MO-269
Overview	DDR3 DIMM Sockets
Product Name	DDR3 DIMM
UPC	883906305840
Physical	
Circuits (Loaded)	240
Circuits (maximum)	240
Durability (mating cycles max)	25
Entry Angle	25° Angle
Flammability	94V-0
Function Key	None
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Black
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	10.859/g
PC Tail Length	2.79mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Packaging Type	Tray
Pitch - Mating Interface	1.00mm
Pitch - Termination Interface	1.00mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55°C to +85°C
Termination Interface: Style	Through Hole
Electrical	
Current - Maximum per Contact	1.0A
Voltage - Maximum	30V AC (RMS)/DC
Voltage Key	Center

EU ELV	
Not Relevant	
EU RoHS	China RoHS
Compliant	
REACH SVHC	
Not Contained Per	
-ED/01/2018 (15	
January 2018)	
Halogen-Free	
Status	
Not Low-Halogen	
Need more information on product	
environmental compliance?	
Email productcompliance@molex.com	
Please visit the Contact Us section for any	
non-product compliance questions.	
China ROHS	Green Image
ELV	Not Relevant
RoHS Phthalates	Not Contained

Search Parts in this Series

78359 Series

Mates With

JEDEC Standard 1.27mm Modules

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
MiniDIMM Memory	0621001960
Card Insertion Tool	

Solder Process Data

Duration at Max. Process Temperature (seconds)	010
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	002
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Electrical Model Document	EE-78359-001
Product Specification	PS-78359-001-001
S-Parameter Model	SP-78359-001
Sales Drawing	SD-78359-001-001

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